PQ070XZ5MZ/ PQ070XZ01Z

■ Features

- Low voltage operation (Minimum operating voltage:2.35V)
 2.5V input → available 1.5 to 1.8V
- 2. Low dissipation current

Dissipation current at no load:MAX.2mA (Conventional model:MAX.10mA)

OFF-state dissipation current:MAX.5µA

■ Applications

- 1. Peripheral equipment of personal computers
- 2. Power supplies for various electronic equipment such as DVD player or STB

■ Model Line-up

Output current (I _O)	Package type	Variable output
0.5A	Taping	PQ070XZ5MZP
	Sleeve	PQ070XZ5MZZ
1A	Taping	PQ070XZ01ZP
	Sleeve	PQ070XZ01ZZ

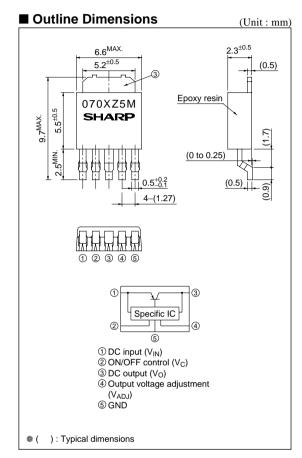
(Ta∍	=2:	5°(\mathbb{C}
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			J -		
Parameter		Symbol	Rating	Unit	
*1 Input vo	ltage	Vin	10	V	
*1 Output control voltage		Vc	10	V	
*1 Output adju	stment terminal voltage	V _{ADJ}	5	V	
Output	PQ070XZ5MZ	Io	0.5	A	
current	PQ070XZ01Z	10	1	A	
*2 Power d	issipation	PD	8	W	
*3 Junction	temperature	Tj	150	°C	
Operatir	ng temperature	Topr	-40 to +85	°C	
Storage	temperature	Tstg	-40 to +150	°C	
Soldering temperature		Tsol	260 (10s)	°C	

^{*1} All are open except GND and applicable terminals

*2 PD:With infinite heat sink

SC-63 Package, Low Voltage Operation Low Power-loss Voltage Regulator



^{*3} Overheat protection may operate at the condition T_i=125°C to 150°C

■ Electrical Characteristics

(Unless otherwise specified, condition shall be $V_{IN}=5V$, $V_0=3V(R_1=1k\Omega)$, $I_0=0.3A$, $V_0=2.7V$, $T_0=25^{\circ}C$, (**PQ070XZ5MZ**)) (Unless otherwise specified, condition shall be $V_{IN}=5V$, $V_0=3V(R_1=1k\Omega)$, $I_0=0.5A$, $V_0=2.7V$, $T_0=25^{\circ}C$, (**PQ070XZ01Z**))

Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input voltage range		Vin	-	2.35	_	10	V
Output voltage		Vo	_	1.5	_	7	V
Load regulation	PQ070XZ5MZ	RegL	Io=5mA to 0.5A	_	0.2	2	%
	PQ070XZ01Z		Io=5mA to 1A				
Line regulation		RegI	V _{IN} =4 to 8V, Io=5mA	_	0.2	1	%
Ripple Rejection		RR	Refer to Fig.2	45	60	_	dB
Dropout voltage	PQ070XZ5MZ	V _{I-O}	V _{IN} =2.85V, Io=0.3mA	_	-	0.5	V
	PQ070XZ01Z		V _{IN} =2.85V, Io=0.5mA				
Reference voltage		Vref	-	1.225	±1.25	1.275	V
Reference voltage temperature coefficient		$T_{\rm C}V_{\rm ref}$	Tj=0 to 125°C, Io=5mA	_	±1.0	_	%
*4 Output on control voltage		V _C (ON)	*4	2	-	_	V
Output on control current		Ic (on)	-	_	_	200	μΑ
Output off control voltage		V _{C (OFF)}	Io=0A	_	_	0.8	V
Output off control current		Ic (OFF)	Io=0A, Vc=0.4V	_	_	2	μΑ
Quiescent current		I_{q}	Io=0A	_	1	2	mA
Output off dissipation current		I_{qs}	Vc=0.4V	_	_	5	μΑ

^{*4} In case of opening control terminal ②, output voltage turns off

Fig.1 Standard Test Circuit

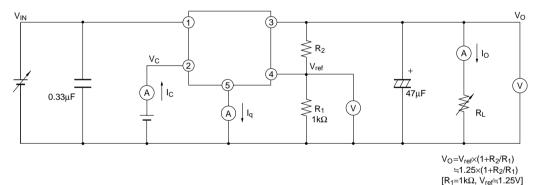


Fig.2 Test Circuit for Ripple Rejection

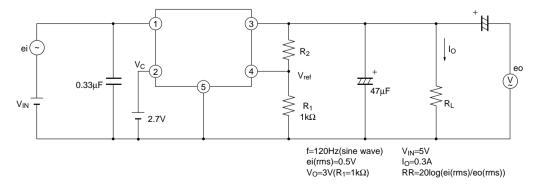
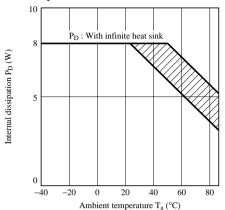


Fig.3 Internal Dissipation vs. Ambient Temperature



Note) Oblique line prtion:Overheat protection may operate in this area

Fig.5 Overcurrent Protection Characteristics (PQ070XZ5MZ)

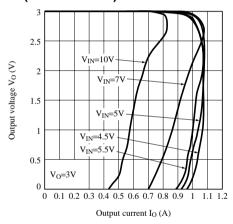


Fig.7 Output Voltage vs. Input Voltage (PQ070XZ5MZ)

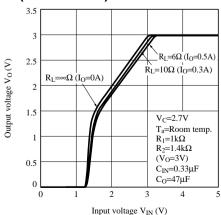


Fig.4 Overcurrent Protection Characteristics (PQ070XZ01Z)

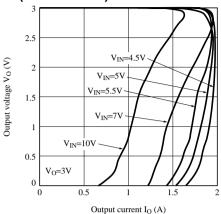


Fig.6 Reference Voltage vs. Ambient Temperature

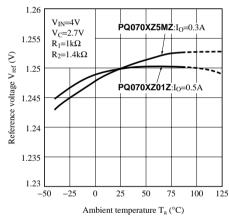


Fig.8 Output Voltage vs. Input Voltage (PQ070XZ01Z)

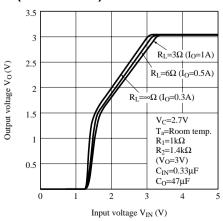


Fig.9 Circuit Operating Current vs. Input Voltage (PQ070XZ5MZ)

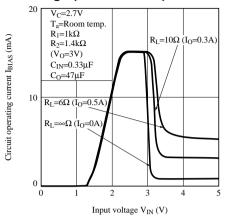


Fig.11 Dropout Voltage vs. Ambient Temperature

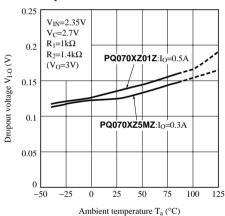


Fig.13 Ripple Rejection vs. Input Ripple Frequency

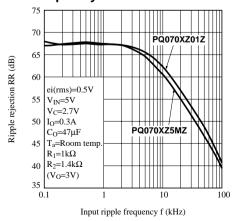


Fig.10 Circuit Operating Current vs. Input Voltage (PQ070XZ01Z)

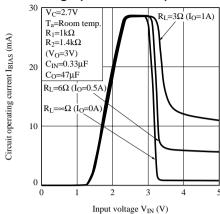


Fig.12 Quiescent Current vs. Ambient Temperature

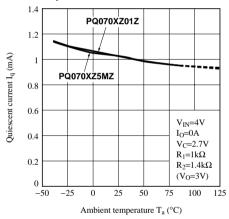


Fig.14 Ripple Rejection vs. Output Current

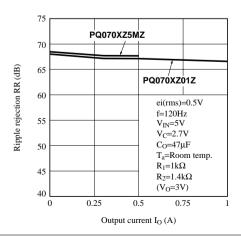


Fig.15 Example of Application

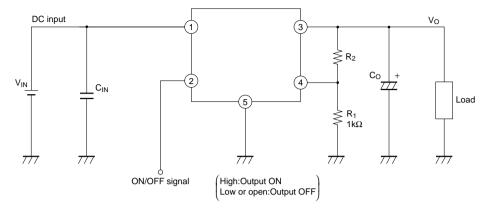
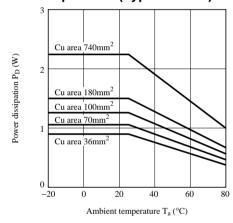


Fig.16 Power Dissipation vs. Ambient Temperature (Typical Value)

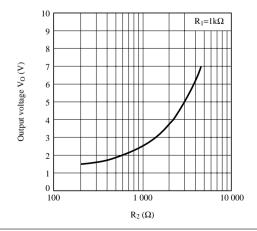




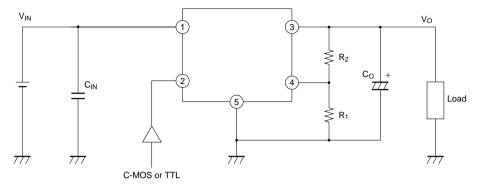
Material : Glass-cloth epoxy resin

Size : $50 \times 50 \times 1.6$ mm Cu thickness : $35 \mu m$

Fig.17 Output Voltage vs. R2



■ Precautions for Use



1. External connection

- (1) The connecting wiring of C_{0} , C_{IN} and each terminal, fin portion must be as short as possible. It may oscillate by type, value and wiring condition of capacitor. Confirm the output wareform in actual using condition beforehand.
- (2) ON/OFF control terminal ② is compatible with LS-TTL. It enables to be directly driven by TTL or C-MOS standard logic (RCA4000 series).
- (3) If voltage is applied under the conditions that device pin is connected divergently or reversely, the deterioration of characteristics or damage may occur. Never allow improper mounting.

2. Thermal protection design

Maximum power dissipation of devices is obtained by the following equation.

$$P_D = I_O \times (V_{IN} - V_O) + V_{IN} \times I_q$$

When ambient temperature T_a and power dissipation P_D (MAX.) during operation are determined, operate element within the safety operation area specified by the derating curve. Insufficient radiation gives an unfavorable influence to the normal operation and reliability of the device.

In the external area of the safety operation area shown by the derating curve, the overheat protection circuit may operate to shutdown output. However please avoid keeping such condition for a long time.

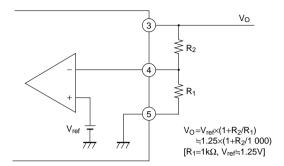
3. ESD (Electrostatic Sensitivity Discharge)

Be careful not to apply electrostatic discharge to the device since this device employs a bipolar IC and may be damaged by electro static discharge. Followings are some methods against excessive voltage caused by electro static discharge.

- (1) Human body must be grounded to discharge the electro charge which is charged in the body or cloth.
- (2) Anything that is in contact with the device such as workbench, inserter, or measuring instrument must be grounded.
- (3) Use a soldering dip basin with a minimum leak current (isolation resistance $10M\Omega$ or more) from the AC power supply line. Also the soldering dip basin must be grounded.

■ Output Voltage Fine Tuning

1. Connecting external resistors R_1 and R_2 to terminals ③, ④, ⑤ allows the output voltage to be fine tuned from 1.5V to 7V. Refer to the figure below and Fig.17 when connecting external resistors for fine tuning output voltage.



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